TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ( $\pi$ -MOSVII)

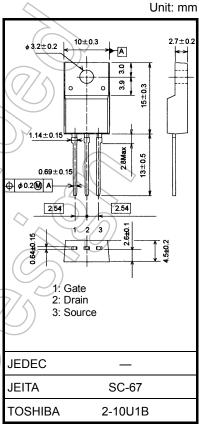
# TK6A60D

#### **Switching Regulator Applications**

- Low drain-source ON-resistance: RDS (ON) =  $1.0 \Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 3.0 \text{ S (typ.)}$
- Low leakage current:  $I_{DSS} = 10 \mu A \text{ (max) (V}_{DS} = 600 \text{ V)}$
- Enhancement mode:  $V_{th} = 2.0 \text{ to } 4.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

# Absolute Maximum Ratings (Ta = 25°C) Characteristics Symbol

Characteristics		Symbol	Rating	Unit	
Drain-source voltage			$V_{DSS}$	600	V
Gate-source voltage			$V_{GSS}$	±30	A
Drain current	DC	(Note 1)	ΙD	6	A
	Pulse	(Note 1)	$I_{DP}$	24	^
Drain power dissipation (Tc = 25°C)			P <sub>D</sub>	40	W
Single pulse avalanche energy (Note 2)			E <sub>AS</sub>	173	(mJ
Avalanche current			IAR	6	A
Repetitive avalanche energy (Note 3)			EAR	4.0	mJ
Channel temperature			(T <sub>ch</sub>	150	∫\°C
Storage temperature range			T <sub>sta</sub>	-55 to 150	S <sub>C</sub>



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

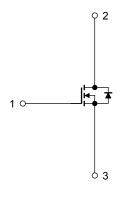
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	3.125	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD} = 90 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial), L = 8.4 mH,  $R_G = 25 \Omega$ ,  $I_{AR} = 6 \text{ A}$ 

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.



Start of commercial production 2008-07

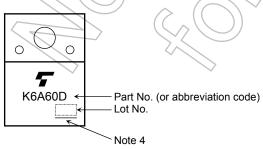
#### **Electrical Characteristics (Ta = 25°C)**

Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μΑ
Drain cut-off current		I <sub>DSS</sub>	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V	_	_	10	μΑ
Drain-source bre	akdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	600	_		٧
Gate threshold v	oltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	٧
Drain-source ON-resistance		R <sub>DS</sub> (ON)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A	(F	) 1.0	1.25	Ω
Forward transfer admittance		Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3 A	0.8	3.0		S
Input capacitance		C <sub>iss</sub>		()	800		
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		4		pF
Output capacitance		Coss		7 <u> </u>	100		
Switching time	Rise time	t <sub>r</sub>	10 V ID = 3 A VOUT	_	20	<u> </u>	
	Turn-on time	t <sub>on</sub>	0 V — FRL = 67 Ω	-6	40	> —	ns
	Fall time	t <sub>f</sub>	/// V <sub>DD</sub> ≈ 200 V		12	) _	115
	Turn-off time	t <sub>off</sub>	Duty ≤ 1%, t <sub>W</sub> = 10 μs	(A)	60	_	
Total gate charge		Qg			16	_	
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 6\text{A}$	) —	10		nC
Gate-drain charge		Q <sub>gd</sub>		_	6	_	

### Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	IDR		_	_	6	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	(7/\\ -	_	_	24	Α
Forward voltage (diode)	V <sub>DSF</sub>	$I_{DR} = 6 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 6 A, V <sub>GS</sub> = 0 V,	_	1200	_	ns
Reverse recovery charge	Qrr	$dI_{DR}/dt = 100 A/\mu s$		10		μС

#### Marking

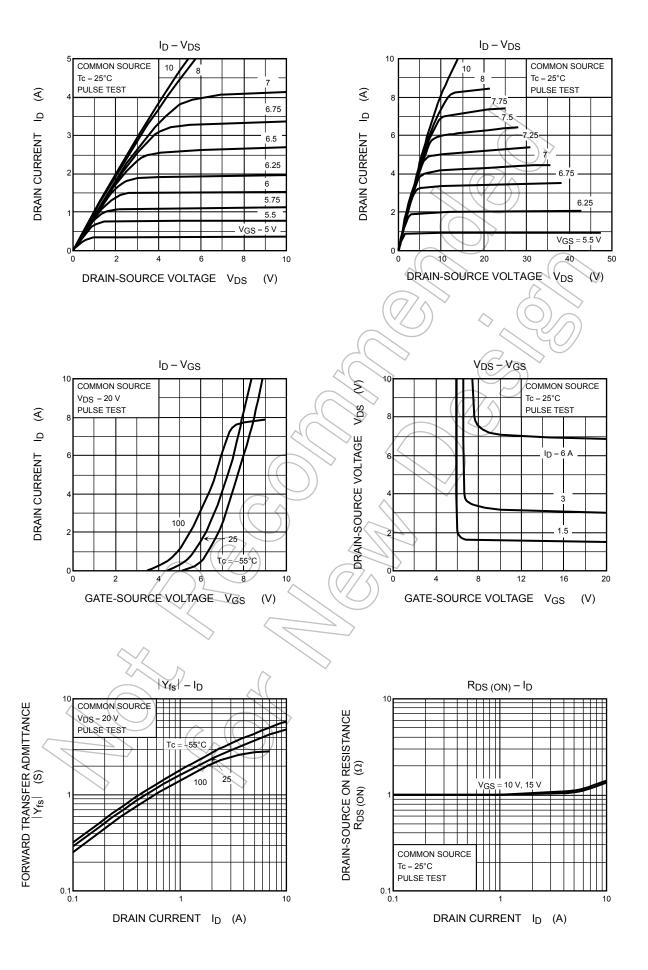


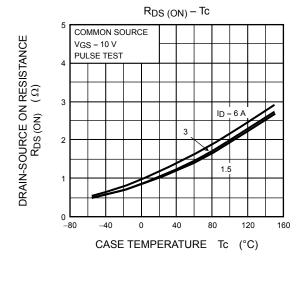
Note 4: A line under a Lot No. identifies the indication of product Labels.

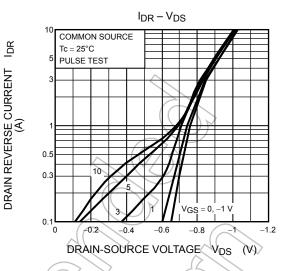
Not underlined: [[Pb]]/INCLUDES > MCV

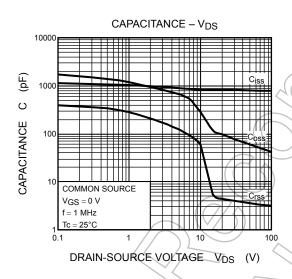
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

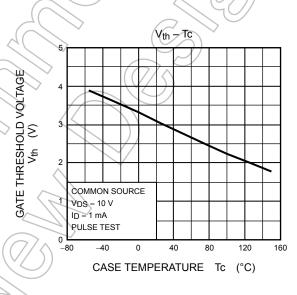
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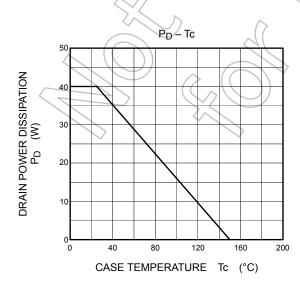


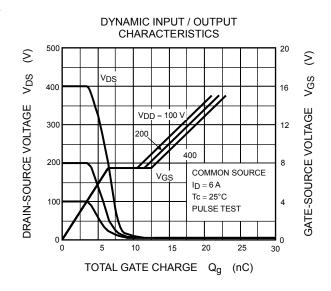


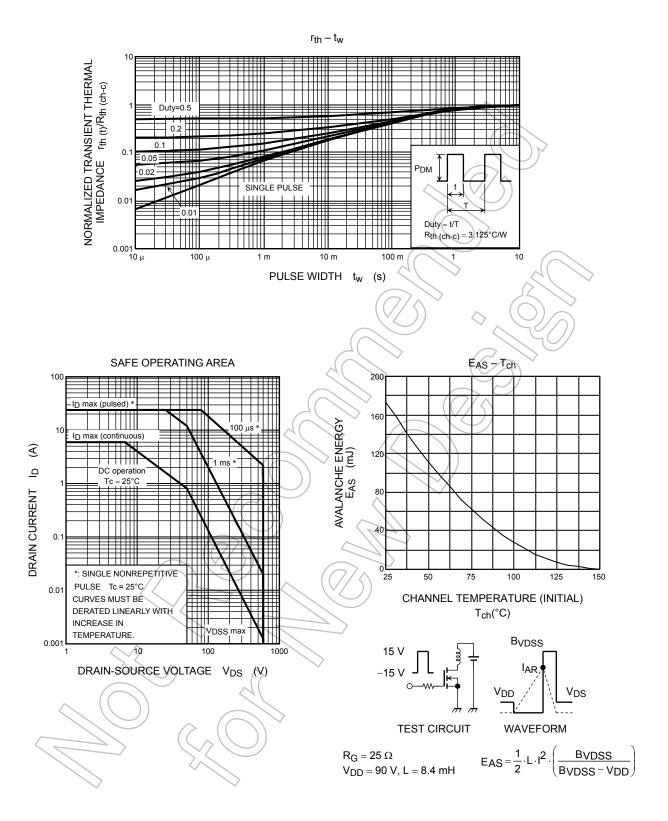












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